Sea	t No.:	Enrolment No	_	
		GUJARAT TECHNOLOGICAL UNIVERSITY ME – SEMESTER II (NEW) – • EXAMINATION – SUMMER 2016		
Subject Code: 3725201 Date: 24 Subject Name: System Design		Code: 3725201 Date: 24/05/20	Date: 24/05/2016	
		larks: 70		
Q.1	(a) (b)	Explain Hardware Software Co-Design for System Design. Explain in detail the following: 1. Single Layer PCB 2. Double Layer PCB 3. Multi Layer PCB	07 07	
Q.2	(a) (b)	Explain the concept of System Design in brief. Explain in detail about the Floating Point and Fixed Point Data formats. OR	07 07	
	(b)	Explain the characteristic impedance property of transmission lines on the Hardware board for signal transmission.	07	
Q.3	(a) (b)	Explain the following I/O data transfer techniques: 1. Program Driven I/O Transfer 2. Interrupt Driven I/O Transfer 3. Direct Memory Access I/O Transfer Explain in detail about the basic components of any typical real time embedded	07	
		system OR		
Q.3	(a)	Explain the followings: 1. Compiler 2. Assembler 3. Linker 4. Debugger	07	
0.4	(b)	Explain the need for prototyping and prototyping using FPGA platforms.	07	
Q.4	(a)	List down the high speed hardware system design challenges and explain any one.	07	
	(b)	Explain in detail power consumption issues in Hardware-Software Co-Design. OR	07	
Q.4	(a) (b)	Define a Real Time Embedded System and describe its characteristics. Explain in brief Chemical Etching: Principles and Mechanisms.	07 07	
Q.5	(a)	Explain the effect of noisy signals in high speed design and list out the rules to keep away the noise effects away from the high speed design. Explain in about the decoupling at (a) IC level and (b) Roard I evel	07 07	
	(b)	Explain in about the decoupling at (a) IC level and (b) Board Level	U/	

(b) Explain in detail about the SPI Bus Interface and the generic software support

Q.5

for the I²C devices.

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OR (a) Explain in detail about the I²C Bus Interface and the generic software support

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